

Rectron unveils DDR3 memory specifically designed for new Core i5, i7 platforms

Rectron has launched a DDR3 1333MHz memory module kit designed for Intel's latest LGA1156 Core i5 and Core i7 platforms.

"Transcend's DDR3 1333MHz dual-channel memory kit is perfectly matched for use with Intel's next-generation desktop PC platform, Core i5," says Werner Joubert, 3C Business Products manager at Rectron, sole distributor of the Transcend brand in South Africa.

"The new Core i5, which is based on Intel's new Nehalem architecture, is the first Intel processor to integrate both a 16-lane PCI Express 2.0 graphics port and a two-channel DDR3 memory controller, enabling all input/output and manageability functions to be handled by the single-chip Intel P55 core-logic."

Transcend's DDR3 1333MHz memory modules is designed to provide high-speed performance at an ultra-low voltage of 1.5V, thus reducing power consumption by 30 percent, compared with DDR2-800 memory.

"Featuring combined bandwidth up to an incredible 21.3GB/sec, these new modules operate at 1333 MHz with latencies of 9-9-9-24, ensuring full support for the performance improvements offered by Intel's latest technology," he added.

These new DDR3 memory modules meet rigorous Joint Electronic Device Engineering Council (JEDEC) standards and consist of 128Mx8 high-quality DDR3 FBGA chips.

"With each module having passed real-world testing on dual-channel platforms, Transcend's new DDR3 memory offers guaranteed quality, outstanding performance, excellent compatibility, as well as superb reliability and stability," he added.

Retailing for R1299, the kit includes two identically matched DDR3 1333MHz modules and is now available in 4GB (2GBx2) capacity.